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PRE-APPEAL BRIEF REQUEST FOR REVIEW		Docket Number (Optional)	
		PEARCE 26	
I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)]	Application Number		Filed
	09/755,826		2001-01-04
on February 26, 2010 First Named		Inventor	
Signature_/Elizabeth Schumacher/	Charles W. Pearce		
	Art Unit		Examiner
Typed or printed Elizabeth Schumacher name	2893		Jack SJ Chen
Applicant requests review of the final rejection in the above-identified application. No amendments are being filed with this request.  This request is being filed with a notice of appeal.  The review is requested for the reason(s) stated on the attached sheet(s). Note: No more than five (5) pages may be provided.  I am the  applicant/inventor.  assignae of record of the entire interest. See 37 CFR 3.71. Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96)  attorney or agent of record. Registration number  44995  Telephone number			
attorney or agent acting under 37 CFR 1.34.		February 26, 2010	
Registration number if acting under 37 CFR 1.34	. Date		
NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below*.			
*Total of forms are submitted.			

This collection of information is required by 35 U.S.C. 132. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11, 1.14 and 41.6. This collection is estimated to take 12 minutes to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Officer, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Charles W. Pearce

Serial No.:

09/755,826

Filed:

January 4, 2001

Title:

METHOD OF MANUFACTURING A LATERALLY DIFFUSED

METAL OXIDE SEMICONDUCTOR DEVICE

Grp./A.U.:

2893

Examiner:

Jack S J Chen

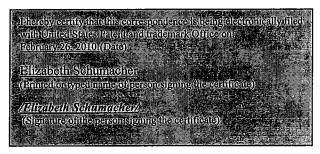
Confirmation No.:

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Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450



Sir:

## PRE-APPEAL BRIEF REQUEST FOR REVIEW

The Applicants have carefully considered this application in connection with the Examiner's Final Rejection mailed November 27, 2009, and respectfully request a pre-appeal brief review of this application in view of the following remarks.

# REMARKS/ARGUMENTS

The Applicants originally submitted Claims 1-20 in the application. Previously, the Applicants amended Claims 1-11 and canceled Claims 4-14 and added new Claims 21-22. In an Election Restriction, the Applicants elected Claims 1-3, 5-9 and 21. Accordingly, Claims 1-3, 5-9 and 21 are currently pending in the application.

### I. Rejection of Claims 1-3, 5-9 and 21 under 35 U.S.C. §103

The Examiner has rejected Claims 1-3 and 5-9 under 35 U.S.C. §103(a) as being unpatentable over U.S. Patent No. 5,841,166 to D'Anna *et al.* ("D'Anna"). Independent Claim 1 currently includes the element of forming a lightly-doped source/drain region between first and second isolation structures and with only a first dopant and

Reply to Examiner's Final Rejection dated November 27, 2009

without the use of a mask layer between the first and second isolation structures. D'Anna fails to teach or suggest this element.

D'Anna is directed to a lateral DMOS transistor for RF/microwave applications. (Title). D'Anna teaches that a P+sinker 44 is formed within a P-epi layer 42. D'Anna then teaches that an N-drift region 46 is formed within the P-epi layer 42 proximate the P+sinker 44. (See, D'Anna at column 2, lines 54-56). Because of this order of formation, the N-drift region 46 inevitably must to use one or more masks during its formation such that it does not counter dope the P+sinker 44. D'Anna then teaches that an active area mask is formed to define where the field oxides 52 will be present, and that the field oxides 52 are then grown to a thickness of 0.5 to 3 microns. (See, D'Anna at column 2, lines 59-65). Accordingly, D'Anna teaches first forming its P+sinker 44, then forming its N-drift region 46 using one or more masks, and only then forming its field oxides 52. In contrast, Claims 1 and 11 currently require first forming first and second isolation structures and then forming a lightly-doped source/drain region between the first and second isolation structures without the use of a mask. As the Examiner likens the N-drift region 46 of D'Anna to the claimed lightly doped source/drain region, as well as the field oxides 52 of D'Anna to the claimed isolation structures, D'Anna must fail to teach or suggest the element of forming a lightly-doped source/drain region between first and second isolation structures, as well as that the lightly-doped source/drain regions are formed with only a first dopant and without the use of a mask layer.

The Examiner, has only begun to argue that the order of forming the isolation structures with respect to the lightly-doped source/drain region is an obvious design choice over the teachings and suggestions of D'Anna. The Applicant strongly disagrees with this assertion. First, D'Anna goes to great effort and expense to form its field oxide regions 52 after formation of its doped sinker region 44 and N- drift region 46. Specifically, D'Anna devotes an entire paragraph (see, Column 2, lines 47-65) to this specific process. Furthermore, D'Anna uses the process of growing the field oxide region 52 to drive in the doped sinker region 44, or vice versa. Accordingly, it is very important to the process of D'Anna that its field oxide region 52 be formed after implantation of its doped sinker

region 44, and thus after implantation of its N- drift region 46--so as to drive in the doped sinker region 44. Accordingly, D'Anna actually teaches away from forming its field oxide region 52 prior to its doped sinker region 44 and N- drift region 46. Such a teaching away makes the modification suggested by the Examiner non-obvious, and thus merely based upon hindsight. The Review Panel is well aware that using hindsight, such as is the case here, is impermissible.

Therefore, D'Anna fails to teach or suggest the invention recited in independent Claim 1 and its dependent claims, when considered as a whole. D'Anna must therefore fail to establish a prima facie case of obviousness with respect to these Claims. It is therefore respectfully submitted that claims 1-3 and 5-9 are therefore not obvious in view of D'Anna.

In view of the foregoing remarks, the cited reference does not support the Examiner's rejection of Claims 1-3 and 5-9 under 35 U.S.C. §103(a). The Applicant therefore respectfully requests the Review Panel to remove the rejection of independent Claim 1 and the Claims dependent thereon.

# II. Rejection of Claims 1-3 and 21 under 35 U.S.C. §103

The Examiner has rejected Claims 1-3 and 21 under 35 U.S.C. §103(a) as being unpatentable over U.S. Patent No. 4,918,026to Kosiak *et al.* ("Kosiak"). As indicated above, independent Claim 1 currently includes the element of forming a lightly-doped source/drain region between first and second isolation structures and with only a first dopant and without the use of a mask layer between the first and second isolation structures. Kosiak fails to teach or suggest this element.

Kosiak is directed to a process for forming a vertical bipolar transistor and high voltage CMOS in a single integrated circuit chip. (Title). Kosiak teaches that lightly doped n-type wells 114, 214, and 314 are formed within a substrate 12. (See, Kosiak at column 4, lines 39-45, and the associated FIG. 2B). Kosiak, by the nature of its manufacturing process, requires that one or more masks 20a, 20b are needed to form its lightly doped n-type wells 114, 214, and 314. Kosiak then teaches that many other processing steps are performed before forming field oxide

regions 50, 120, 220, 320, and 322 to isolate various different features of the monocrystalline silicon chip 10. (See, Kosiak at column 5, lines 40-55, and the associated FIG. 2E). Accordingly, Kosiak teaches first forming its lightly doped n-type wells 114, 214, and 314 using one or more masks 20a, 20b, and then forming its field oxide regions 50, 120, 220, 320, and 322. This is in direct contrast to that presently claimed within independent Claims 1 and 11, which require forming a lightly-doped source/drain region between first and second isolation structures and with only a first dopant and without the use of a mask layer between the first and second isolation structures. Thus, Kosiak fails to disclose this claimed element.

The Examiner, again only recently, argues that the order of forming the isolation structures with respect to the lightly-doped source/drain region is an obvious design choice over the teachings and suggestions of Kosiak. The Applicant strongly disagrees with this assertion. First, Kosiak goes to great effort and expense to form its field oxide regions 50, 120, 220, 320 and 322 after formation of its lightly doped n-type wells 114, 214, and 314. Specifically, Kosiak devotes many paragraphs (see, Column 5, lines 1-45) to this specific process. Furthermore, Kosiak uses the process of growing the field oxide regions 50, 120, 220, 320 and 322 to drive in the boron implanted regions 208 and 308, or vice versa. Nevertheless, as this is a vertical bipolar transistor, the lightly doped n-type wells 114, 214, which contain the boron implanted regions 208 and 308, must be formed prior to the boron implanted regions 208 and 308 themselves. Accordingly, it is very important to the process of Kosiak that its field oxide regions 50, 120, 220, 320 and 322 be formed after implantation of its boron implanted regions 208 and 308, so as to drive them into the substrate, and further that the boron implanted regions 208 and 308 ultimately need be formed after implantation of its lightly doped n-type wells 114, 214. Accordingly, Kosiak actually teaches away from forming its field oxide regions 50, 120, 220, 320 and 322 prior to its boron implanted regions 208 and 308 and lightly doped n-type wells 114, 214. Such a teaching away makes the modification suggested by the Examiner non-obvious, and thus merely based upon hindsight. The Examiner is well aware that using hindsight, such as is the case here, is impermissible.

Therefore, Kosiak fails to teach or suggest the invention recited in independent Claim 1 and its dependent

claims, when considered as a whole. Kosiak must therefore fail to establish a prima facie case of obviousness with

respect to these Claims. It is therefore respectfully submitted that claims 1-3 and 21 are therefore not obvious in view

of Kosiak.

In view of the foregoing remarks, the cited reference does not support the Examiner's rejection of Claims

1-3 and 21 under 35 U.S.C. §103(a). The Applicant therefore respectfully requests the Review Panel to remove the

rejection of independent Claim 1 and the Claims dependent thereon.

III. Conclusion

In view of the foregoing remarks, the Applicant sees all of the Claims currently pending in this application

to be in condition for allowance and therefore earnestly solicits a Notice of Allowance for Claims 1-3, 5-9 and 21.

The Applicant requests the Reviewers to telephone the undersigned attorney of record at (972) 480-8800 if

such would further or expedite the prosecution of the present application. The Commissioner is hereby authorized to

charge any fees, credits or overpayments to Deposit Account 08-2395.

Respectfully submitted,

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Dated:

February 26, 2010

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